

Note 1) "typ" is used where no dimensional tolerance applies.

| Item | Description | | | | | | | | |
|-----------------------------|--|--|--|--|--|--|--|--|--|
| Appearance/ construction | Product surface shall be covered with a protective film, which does not easily separate nor present noticeable unevenness, scratches, pinholes, color changes etc. | | | | | | | | |
| | Terminals shall ensure practically acceptable quality. | | | | | | | | |
| | Substrate shall be as shown in the drawing with no excessive chippings, scratches, burrs, or cracks. | | | | | | | | |
| Marking | Shall be legible in white (with printing paste). | | | | | | | | |
| Remarks | marked side for pin 1. | | | | | | | | |

| Directional Coupler | | Delivery S | Specifica | tion | EHFFD1542 | | | |
|-------------------------------|-------|------------|-----------|--------|-----------------------------------|--|--|--|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Appearance | | | |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF-FD1542 9-1 | | | |

[Absolute maximum ratings]

| No. | Item | Symbol | Rating | Unit | Remarks |
|-----|-----------------------|--------|--------|------|-------------------|
| 1 | Maximum input power | Pmax | 5 | V | DC voltage is 0V. |
| 2 | Operating temperature | Topr | -30+85 | degC | |
| 3 | Storage temperature | Tstg | -40+85 | degC | |

Note: This component cannot apply a DC Bias.

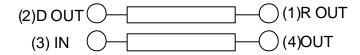
[Electrical characteristics]

T = +25 + / -5 degC

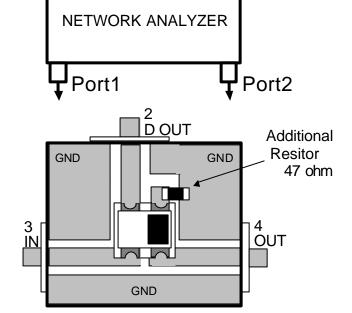
| No. | Item | Test | | Unit | | |
|-----|--------------------|---------|------|------|------|-----|
| | | Circuit | Min. | Тур. | Max. | |
| 1 | Frequency | - | 1850 | 1900 | 1950 | MHz |
| 2 | Insertion loss 2-1 | Fig-1 | - | - | *0.3 | dB |
| 3 | Coupling 2-3 | Fig-1 | 19 | 20 | 21 | dB |
| 4 | Isolation 1-3 | Fig-1 | 26 | - | - | dB |
| 5 | Input VSWR | Fig-1 | - | - | 1.3 | - |

^{*} Value of insertion loss is not included the Test Board Loss(0.2dB)

[Internal circuitry]



[Measuring circuit]



- < Insertion loss & VSWR measurement >
- (3)IN=Port1, (4)OUT=Port2 (2)Detect OUT is connected 50 ohm.
- < Coupling measurement > (3)IN=Port1, (2)Detect OUT=Port2 (4)OUT is connected 50 ohm.
- < Isolation measurement > (4)OUT=Port1, (2)Detect OUT=Port2 (3)IN is connected 50 ohm.

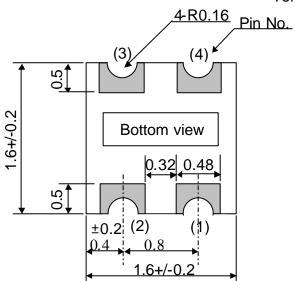
| Directional Coupler | D | elivery S | pecificat | ion | EHF FD1542 | |
|-------------------------------|-------|-----------|-----------|--------|---------------------------------|--|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Specification and measurement | |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF- FD1542 9-2 | |

[Terminal dimensions] Unit: mm

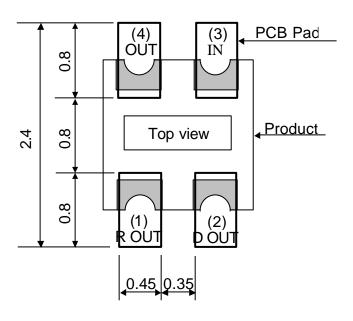
<Bottom>

Tolerance of

Terminal dimensions: +/-0.16

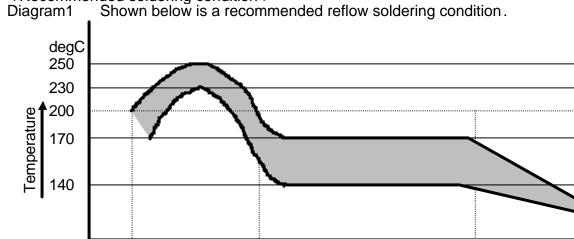


[Recommended PCB pad dimensions] Unit: mm



| Directional Coupler | D | elivery S | pecificat | ion | EHF FD1542 | | | | |
|-------------------------------|-------|-----------|-----------|--------|------------------------------------|--|--|--|--|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Terminals/Recommended lands | | | | |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF- FD1542 9-3 | | | | |

| Test item | Test item Test condition | | | | | | |
|---|---|---|--|--|--|--|--|
| High temperature | +85degC, 1000h | No abnormality shall be observed in | | | | | |
| Low temperature | -40degC, 1000 h | appearance or | | | | | |
| High-temperature high-humidity storage | +60degC, 90%RH, 1000h | electrical characteristics. | | | | | |
| Pressure Pot | +121degC, 99%RH, 2.026x10 ⁵ Pa, 100h | Characteristics. | | | | | |
| Temperature cycling | -40+85degC, Each 30 min., 200cy | | | | | | |
| Vibration | 10500Hz, 10G, in each direction of XYZ, 2h30min. | | | | | | |
| Impact | 100G, 6mS, Half sinusoidal wave, in each direction of XYZ, 3 times | | | | | | |
| Shock (Drop) | 1.8m, 6 facesx6cy(36 times with 100g Dummy Load) | | | | | | |
| Electro static discharge | · · · · · · · · · · · · · · · · · · · | | | | | | |
| Soldering heat resistance | Manual hot gas: 260+/-10degC, 30 sec., 2 times | Over 90% of the terminal surface shall be covered | | | | | |
| | Soldering iron: 260+/-10degC, 3 sec., 2 times | with solder. | | | | | |
| | Reflow: 260degC peak, 2 times | | | | | | |
| Solder ability | Solder bath: 235+/-5degC, 2 sec. | Over 95% of the terminal surface shall be covered | | | | | |
| | Reflow: 230degC | with solder. | | | | | |
| Board warping | Assemble this component on a PC board with 0.8mm thickness using the recommended soldering condition shown below, and apply a bending force of 3mm warping at a rate of 1mm/sec. 5 seconds and 5 times. 45mm 45mm 45mm | There should not be any cracks in the component or solder joints, no abnormality in electrical characteristics. | | | | | |
| Terminal removal Solder a component on a PC board using the recommended condition show then press the component sideways at 1mm/sec. Destruction limit 9.8N or great results of the press the component sideways at 1mm/sec. | | | | | | | |
| Seating plane co-planarity | Within 0.1mm | | | | | | |



30~60 sec.

| Directional Coupler | D | elivery S | pecificat | ion | EHF FD1542 | |
|-------------------------------|-------|-----------|-----------|--------|------------------------------------|--|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Quality Characteristics | |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF- FD1542 9-4 | |

60~180 sec.

Time

[Cautions for use]

- (1) Operating a product over the maximum rating for even a moment may result in a product failure or breakage. Never use a product in such a condition that it may cause a safety problem.
- (2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
- (3) Operations in a corrosive gas atmosphere or improper environments such as high-temperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
- (4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
- (5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
- (6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
- (7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
- (8) This product does not include a DC-cutting device. Application of a DC Current may cause product deterioration or breakage.
 - * If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.

[Remarks]

- *1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
- *2: The production process of this product does not use any ozone-depleting chemicals (OZC) regulated by the Montreal Protocol.
- *3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

| Directional Coupler | D | elivery S | EHF FD1542 | | |
|-------------------------------|-------|-----------|------------|--------|------------------------------------|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Cautions |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF- FD1542 9-5 |

[Packaging materials]

- 1. Materials
- 1) Embossed carrier tape (Refer to the attachment)
 2) Top tape: Anti-static

- 3) Packaging box (Refer to the attachment)4) Packaging tape, carrier-securing adhesive tape

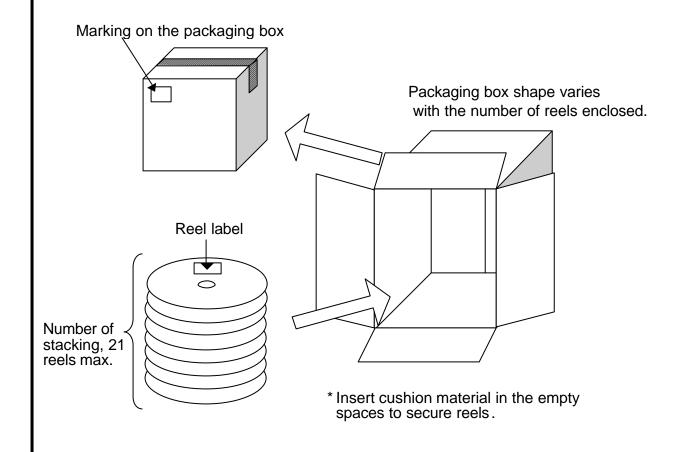
2. Specification

| No. | Item | Condition | Remarks |
|------|---|--|--|
| 1 | Reel outer diameter | Refer to the attachment. | |
| 2 | Reel inner diameter | Refer to the attachment. | |
| 3 | Reel inner width | Refer to the attachment. | |
| 4 | Quantity in a reel | 4000 pieces/reel | |
| 5 | Taping direction | Tape unreeling direction (with markings facing up) | |
| 6 | Top tape attachment position | Top tape 8.0+-0.2mm 5.5mm Top tape -0.2mm -0.2m | Tape breaks force. Min. 10N Top cover tape strength. Min. 10N Tape peel force. 0.11.0N Tape peel angle. 165180degree Reel weight. Max 1500g |
| 7 | Label attachment position | Tape unreeling direction Label | Indicated Item Pat No., Lot No. Quantity, Maker Country |
| 8 | Tape leader part and tape ending part | Ending part Product-loaded part Embossed carrier Top tape 200~220mm (Product-unloaded part) 100~150mm, 25~38 pieces worth, (Product-unloaded part) 300~ 400mm | |
| 9 | Missing products | No missing products shall be allowed. | |
| 10 | | | 84000 pieces/box(Max) |
| Diro | ctional Coupler | Dolivery Specification EUE I | ED1542 |

| Directional Coupler | EHF FD1542 | | | | | |
|-------------------------------|------------|-----------|-----------|--------|---------------------------------|--|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Packaging specification 1 | |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF- FD1542 9-6 | |

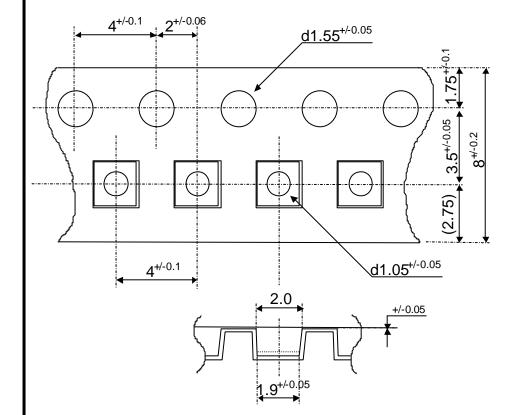
1. Method

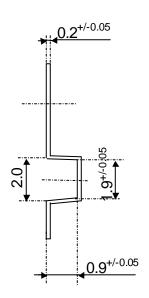
- 1) Load products in each cavity of an embossed carrier tape, in the correct orientation, by leaving the product-unloaded part shown in Item No. 8(P9-6) of the packaging specification.
- 2) Heat-seal a top tape in good alignment on the carrier tape.
- 3) After 4000 pieces are loaded and reeled, provide a product-unloaded part at the tape-leader portion. Secure the tip of the carrier tape with a piece of adhesive tape.
- 4) Stack the reels (21 reels max.) and enclose them in a packaging box. Close the flaps with a piece of adhesive tape.
- 5) Provide markings on the packaging box.
 - < Items to be indicated >
 - 1. Part No.
 - 2. Quantity
 - 3. Lot No.
 - 4. Manufacturer name
 - 5. Country of origin



| Directional Coupler | D | elivery S | pecificat | ion | EHF FD1542 | | | |
|-------------------------------|-------|-----------|-----------|--------|------------------------------------|--|--|--|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | Packaging specification 2 | | | |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | Drawing No. 151-EHF- FD1542 9-7 | | | |

[Embossed tape reel dimensions] Unit: mm

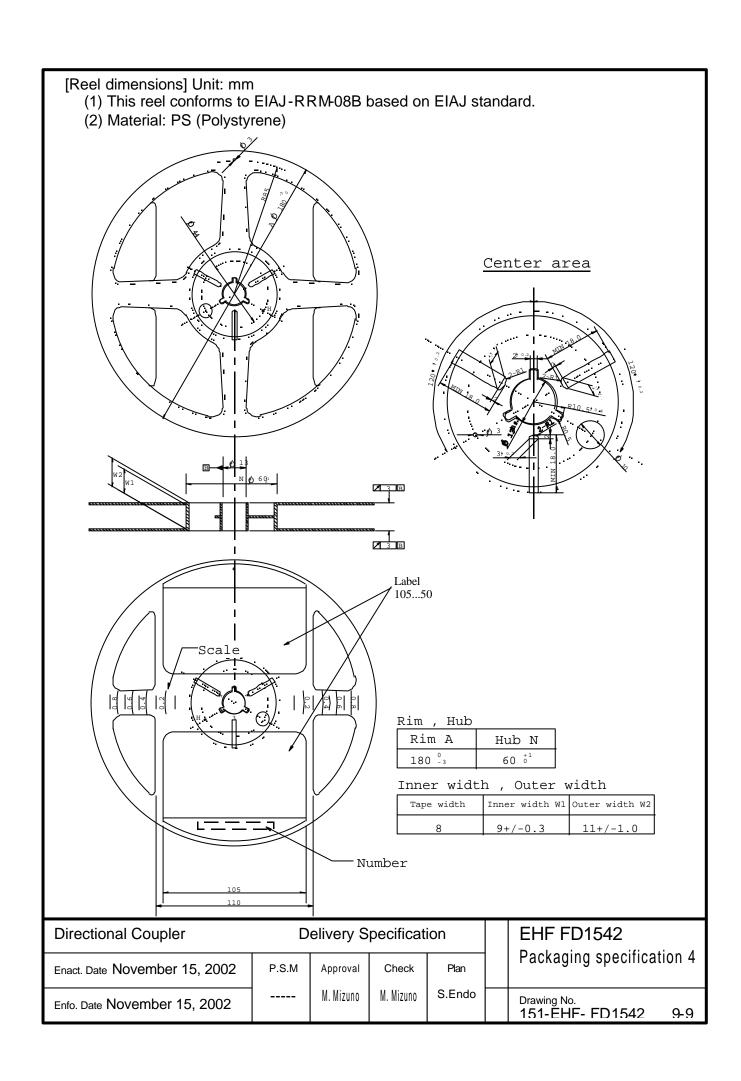




<Remarks>

- (1) Unspecified corner radius shall be 0.3mm max.
- (2) Cumulative pitch error of sprocket holes shall be +/-0.2mm for 10 pitches.

| Directional Coupler | onal Coupler Delivery Specification | | | | | EHF FD1542 |
|-------------------------------|-------------------------------------|-----------|-----------|--------|--|------------------------------------|
| Enact. Date November 15, 2002 | P.S.M | Approval | Check | Plan | | Packaging specification 3 |
| Enfo. Date November 15, 2002 | | M. Mizuno | M. Mizuno | S.Endo | | Drawing No. 151-EHF- FD1542 9-8 |



单击下面可查看定价,库存,交付和生命周期等信息

>>Panasonic(松下)